

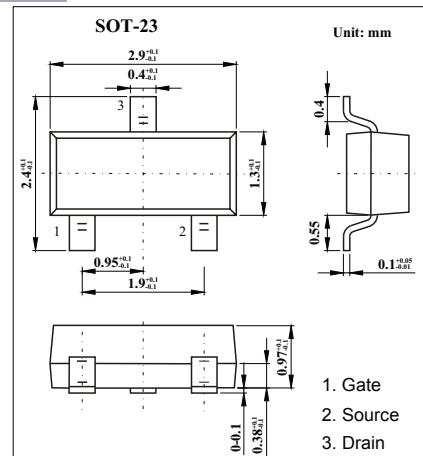
## SOT-23 Plastic-Encapsulate MOSFETS

**Features**

- V<sub>DSD</sub>=-30V, r<sub>D(on)</sub>=0.080Ω, V<sub>GSD</sub>=-10V, I<sub>D</sub>=-3A
- V<sub>DSD</sub>=-30V, r<sub>D(on)</sub>=0.140Ω, V<sub>GSD</sub>=-4.5V, I<sub>D</sub>=-2.5A
- P-Channel 30-V (D-S) MOSFET

**MECHANICAL DATA**

- Case style:SOT-23molded plastic
- Mounting position:any


**MAXIMUM RATINGS AND CHARACTERISTICS**

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DSD</sub>	-30	V
Gate-Source Voltage	V <sub>GSD</sub>	±20	V
Continuous Drain Current TA=25°C TA=70°C	I <sub>D</sub>	-3 -2.5	A
Pulsed Drain Current *	I <sub>DM</sub>	-12	A
Power Dissipation TA=25°C TA=70°C	P <sub>D</sub>	1.25 0.8	W
Maximum Junction-to-Ambient *	R <sub>thJA</sub>	130	°C/W
Junction Temperature,Storage Temperature	T <sub>j,Tstg</sub>	-55 to 150	°C

\* . Pulse width limited by maximum junction temperature

**MOSFET ELECTRICAL CHARACTERISTICS Ta=25 °C unless otherwise specified**

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -10 iA	-30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -24 V, V <sub>GS</sub> = 0 V			-1	μA
		V <sub>DS</sub> = -24 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			-10	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V			±100	nA
Gate Threshold Voltage	V <sub>GSD(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 iA	-1.0			V
Drain-Source On-State Resistance *	r <sub>D(on)</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -3 A		0.064	0.080	Ω
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -2.5 A		0.103	0.140	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≤ -5 V, V <sub>GS</sub> = -10 V	-6			A
Forward Transconductance *	g <sub>f</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -3 A		4.5		S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0, f = 1 MHz	565			pF
Output Capacitance	C <sub>oss</sub>		126			
Reverse Transfer Capacitance	C <sub>rss</sub>		75			
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -15V ,V <sub>GS</sub> = -10 V , I <sub>D</sub> = -3A	10	15		nC
Gate-Source Charge	Q <sub>gs</sub>		1.9			
Gate-Drain Charge	Q <sub>gd</sub>		2			
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-15V,R <sub>L</sub> =15Ω,I <sub>D</sub> =-1A,V <sub>GEN</sub> =-10V,R <sub>G</sub> =6Ω	10	20		ns
	t <sub>r</sub>		9	20		
Turn-Off Time	t <sub>d(off)</sub>		27	50		
	t <sub>f</sub>		7	16		
Continuous Source Current (diode conduction)	I <sub>s</sub>			-1.25		A
Diode Forward Voltage *	V <sub>SD</sub>	I <sub>s</sub> = -1.25 A, V <sub>GS</sub> = 0 V			-1.2	V

\* Pulse test: PW≤300is duty cycle≤2%.

Marking	A7SHB
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